

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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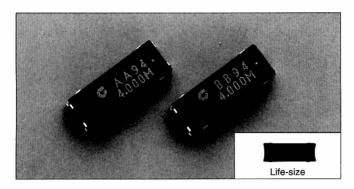




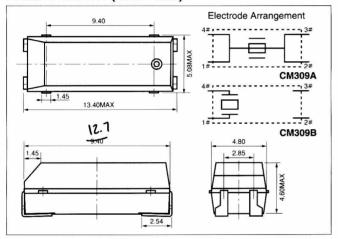
MHz RANGE CRYSTAL UNITS (PLASTIC SURFACE MOUNT TYPE)

CM309A/CM309B

(1,000pcs/reel)



■ DIMENSIONS: (UNIT=mm)



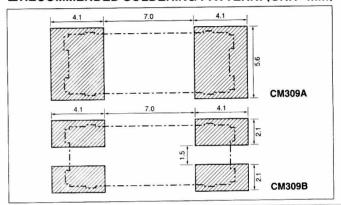
■FEATURES:

- Being of the miniature SMD type and featuring high efficiency in mounting, the CM309S is ideal for application to high-density circuit boards.
- As it incorporates a heat-resisting packaged cylinder-type crystal, this crystal makes best use of the superb characteristic AT-cut crystals have, and permits reflow soldering.
- Enables automatic mounting, due to the adoption of the emboss taping packaging.

■APPLICATIONS:

Can be used for a wide range of applications including use in communication equipment, AV equipment, OA equipment and measuring instruments.

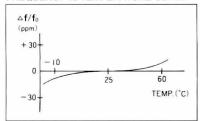
■ RECOMMENDED SOLDERING PATTERN: (UNIT=mm)



■STANDARD SPECIFICATIONS

Item	Model	CM309A/CM309B	Conditions
Nominal frequency	fo	3.5MHz~32MHz (fund), 30MHz~70MHz (3rd OT)	Please contact us for changes in frequency.
Frequency tolerance	△f/f₀	±30ppm or ±50ppm	At 25°C
Frequency vs. Temperature characteristics	△f/f₀	±50ppm (±30ppm)	-10°C~+60°C
Operating temperature range	TORP	−40°C~+85°C	
Storage temperature range	Тѕтс	−55°C~+125°C	
Equivalent series resistance	Rı	See drawing	At 25°C
Load capacitance	CL	16pFTYP	Please specify
Shunt capacitance	Co	7.0pF MAX.	
Drive level	DL	50μW~100μW	
Insulation resistance	IR	500MΩ MIN.	DC100V±15V
Aging (First year)	△f/f₀	±5ppm MAX.	25°C±3°C
Sealing		1 x 10 ⁻² µ Pa⋅m³/s MAX.	
Shock resistance	Drop test of	$\pm 5ppm~MAX$. 3 times on a hard board from 75cm height or shock test of 3000G x 0.3ms x $^{1}/_{2}$ sin wave x 3 directions	Conditions will vary depending on the frequency.

FREQUENCY vs TEMPERATURE CURVE



EQUIVALENT SERIES RESISTANCE (ESR, R1)

Frequency	Equivalent series resistance	Mode	
3.5MHz≦fo< 4MHz	200	fundamental	
4MHz≦fo< 6MHz	150		
6MHz≦f₀<10MHz	100		
10MHz≦f₀≦32MHz	50		
30MHz <fo<36mhz< td=""><td>100</td><td colspan="2" rowspan="2">3rd OT</td></fo<36mhz<>	100	3rd OT	
36MHz≦fo<70MHz	80		

(Ω MAX.)